

钍地半导体
Tudi Semiconductor

Product Specification

TUDI-SN74AHCT1G32

Single 2-Input Positive-OR Gate

网址 www.sztdbdt.com

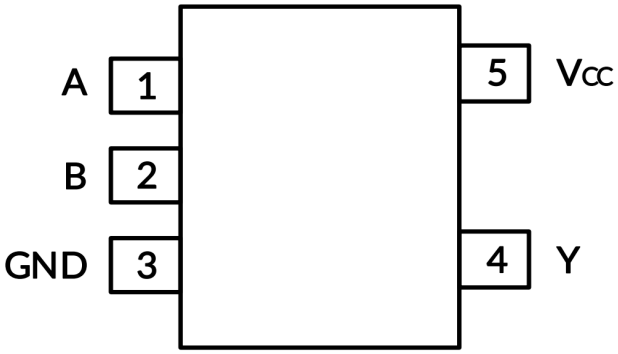
用芯智造·卓越品质

semiconductor device manufacturer

- Design
- research and development
- production
- and sales

FEATURES

- Operating Voltage Range: 2.0V to 5.5V
- Low Power Consumption: 0.1μA (TYP)
- Operating Temperature Range: -40°C to 125°C
- TTL Input are Compatible
- Input Accept Voltage to 5.5V
- Output Drive: ±32mA at V_{CC}=5.0V
- I_{off} Supports Partial-Power-Down Mode Operation
- Micro SIZE PACKAGES: SOT23-5, SC70-5



SOT23-5/SC70-5

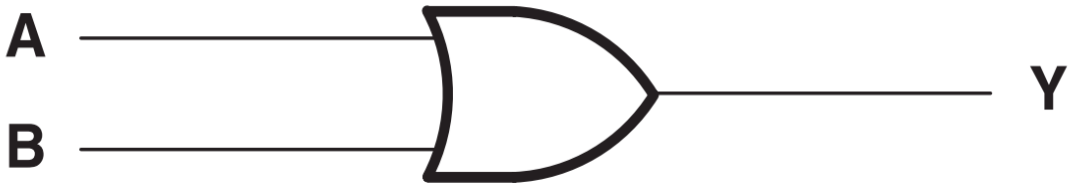
APPLICATIONS

- AV Receiver
- Blu-ray Player and Home Theater
- Digital Picture Frame (DPF)
- High-Speed Data Acquisition and Generation
- Personal Navigation Device (GPS)
- Portable Media Player

DESCRIPTIONS

The SN74AHCT1G32 single 2-input positive-OR gate is designed for 2.0V to 5.5V V_{CC} operation. The SN74AHCT1G32device performs the Boolean function Y=A + B or Y= A●B in positive logic. The device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The SN74AHCT1G32 is available in Green SOT23-5 and SC70-5 packages. It operates over an ambient temperature range of -40°C to 125°C.

LOGIC SYMBOL



FUNCTION TABLE

INPUTS		OUTPUT
A	B	Y
H	H	H
L	H	H
H	L	H
L	L	L

Y=A+B
H=High Voltage Level
L=Low Voltage Level

PIN CONFIGURATION AND FUNCTIONS (TOP VIEW)

PIN	NAME	I/O	DESCRIPTION
1	A	1	Input
2	B	I	Input
3	GND	G	Ground
4	Y	O	Output
5	Vcc	P	Power Pin

Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1) (2)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		-0.5	6.5	V
V_I	Input voltage range(2)		-0.5	6.5	V
V_O	Voltage range applied to any output in the high-impedance orpower-off state (2)		-0.5	6.5	V
V_O	Voltage range applied to any output in the high orlow state (2)(3)		-0.5	V_{CC}+0.5	V
I_{IK}	Input clamp current	V_I <0		-50	mA
I_{OK}	Output clamp current	V_O<0		-50	mA
I_O	Continuous output current			±50	mA
	Continuous current through V_{CC} orGND			±100	mA

Package Thermal Impedance

	PARAMETER		MIN	MAX	UNIT
θ_{JA}	Package thermal impedance(4)	SOT23-5 SC70-5		230 380	°C/W

Temperature

	PARAMETER	MIN	MAX	UNIT
Temperature	Junction temperature,T,(5)	-65	150	°C
	Storage temperature,T_{stg}	-65	150	

ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

	VALUE	UNIT
Human-Body Model(HBM)	±2000	V
Charged-Device Model(CDM)	±1000	
Machine Model (MM)	±200	

ESD SENSITIVITY CAUTION



ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

NOTE:
(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not
implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) The input and output negative-voltage ratings may be exceeded if the input and output
current ratings are observed.
(3) The value of V_{CC} is provided in the Recommended Operating Conditions table.
(4) The package thermal impedance is calculated in accordance with JESD-51.
(5) The maximum power dissipation is a function of $T_{J(MAX)}$, $R_{\theta JA}$, and T_A. The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{\theta JA}$. All numbers apply for packages soldered directly onto a PCB.

ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (TYP values are at T_A = +25°C, Full=-40°C to 125°C, unless otherwise noted.) (1)

Recommended Operating Conditions

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Supply voltage	V_{CC}	Operating	2.0	5.5	V
		V_{CC}=2.0V	1.0		V
High-level input voltage	V_{IH}	V_{CC}=3.3V	1.5		
		V_{CC}=4.5V to 5.5V	2.0		
Low-level input voltage		V_{CC}=2.0V		0.3	V
	V_{IL}	V_{CC}=3.3V		0.55	
		V_{CC}=4.5V to 5.5V		0.8	
Input voltage	V_I		0	5.5	V
Output voltage	V_O		0	V_{CC}	V
Input transition rise or fall	△t/△v	V_{CC}=2.0V to 5.5V		5	ns/V
Operating temperature	T_A		-40	125	℃

(1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

DC Characteristics

PARAMETER	TEST CONDITIONS	Vcc	TEMP	MIN(2)	TYP(3)	MAX(2)	UNIT
VOH	IOH=-100μA	2.0V to 5.5V	Full	VCC-0.1			V
	IOH=-8mA	2.0		1.6			
	IOH=-24mA	3.3		2.5			
		4.5V		3.8			
	IOH=-32mA	5V		4.2			
		5.5V		4.8			
VOL	IOL=100μA	2.0V to 5.5V	Full			0.1	V
	IOH=8mA	2.0				0.45	
	IOH=24mA	3.3				0.55	
		4.5V				0.55	
	IOL=32mA	5V				0.5	
		5.5V				0.45	
II A or B inputs	VI=5.5V or GND	0V to 5.5V	+25℃		±0.1		μA
			Full			±5	
Ioff	VI or VO=5.5V	0V	+25℃		±0.1		μA
			Full			±10	
ICC	VI=5.5V or GND,IO=0	2.0V to 5.5V	+25℃		0.1		μA
			Full			10	
ICCT	One input at 3.4V, Other inputs at VCC orGND	5.5V	Full			500	μA
Ci (InputCapacitance)	VCC=0V,f=10MHz	0V	+25℃		6		pF

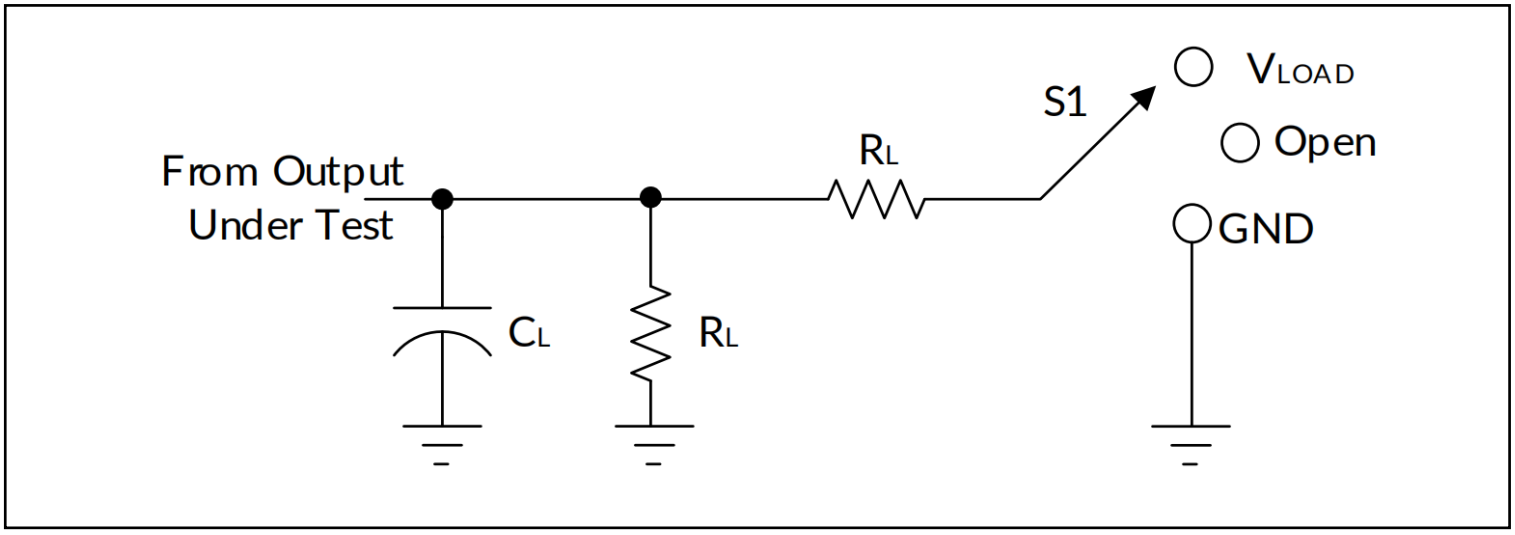
(1) All unused inputs of the device must be held at VCC or GND to ensure proper device operation.
(2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.

AC Characteristics

PARAMETER	SYMBOL	TEST CONDITIONS		MIN(2)	TYP(3)	MAX(2)	UNIT
Propagation Delay	t_{pd}	V_{CC}=2.0V±0.2V	C_L=30pF,R_L=500Ω		3.8		ns
		V_{CC}=3.3V±0.3V	C_L=50pF,R_L=500Ω		2.6		
		V_{CC}=5V±0.5V	C_L=50pF,R_L=500Ω		2.8		
Power dissipation capacitance	C_{pd}	V_{CC}=5V	f=10MHz		25		pF

(1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.
(2) This parameter is ensured by design and/or characterization and is not tested in production.
(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.

PARAMETER MEASUREMENT INFORMATION



TEST	S1
t_{pLH}/t_{pHL}	Open
t_{pLz}/t_{pzL}	V_{LOAD}
t_{pHz}/t_{PZH}	GND

INPUTS

V_{CC}	V_I	t_r/t_f	V_M	V_{LOAD}	C_L	R_L	V_Δ
2.0V±0.2V	V_{CC}	≤2ns	$V_{CC}/2$	$2\times V_{CC}$	30pF	500Ω	0.15V
3.3V±0.3V	3V	≤2.5ns	1.5V	6V	50pF	500Ω	0.3V
5V±0.5V	V_{CC}	≤2.5ns	$V_{CC}/2$	$2\times V_{CC}$	50pF	500Ω	0.3V

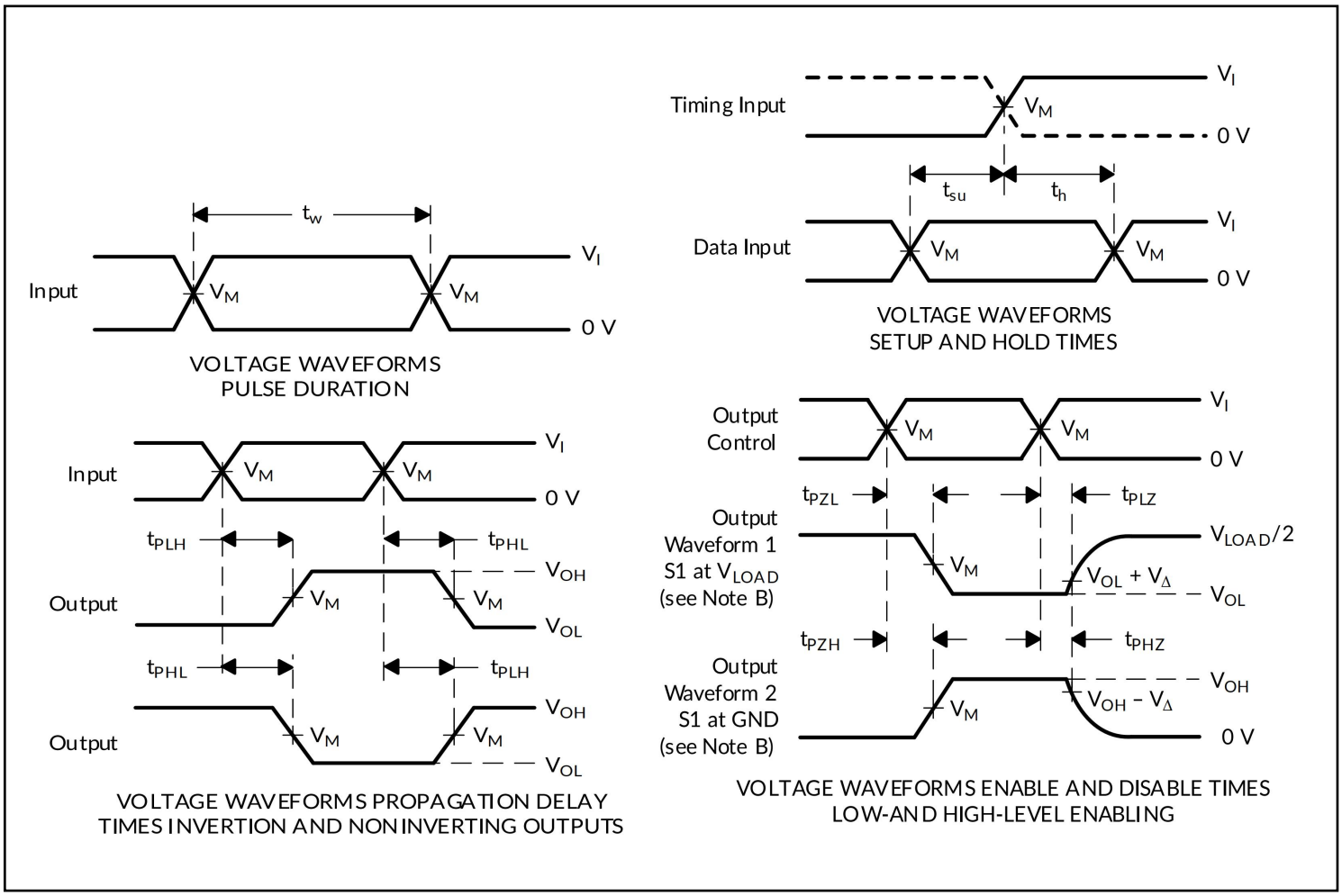


Figure 1. Load Circuit and Voltage Waveforms

NOTES: A. CL includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR $\leq$ 10 MHz, ZO = 50Ω.
D. The outputs are measured one at a time, with one transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
F. t_{PZL} and t_{PZH} are the same as t_{en}.
G. t_{PLH} and t_{PHL} are the same as t_{pd}.
H. All parameters and waveforms are not applicable to all devices.

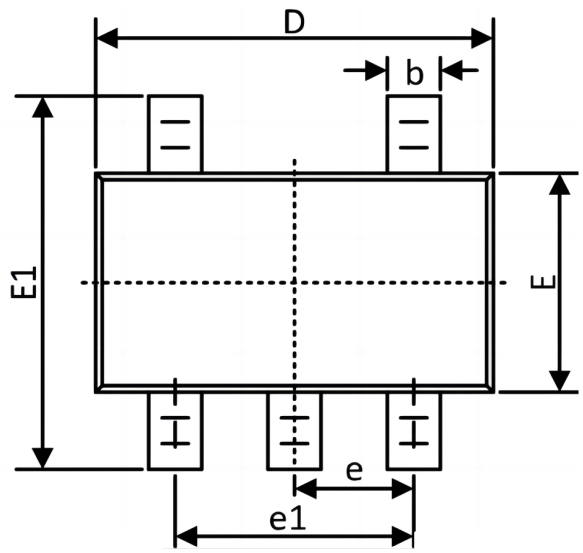
Order information

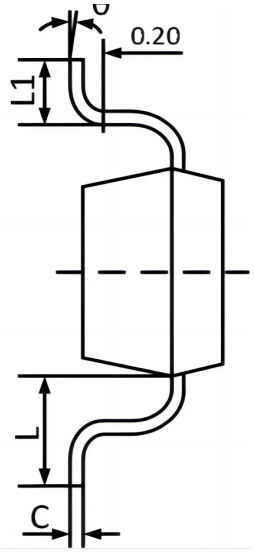
Order Number	Package	Package Quantity	Marking On The park	Temperature
SN74AHCT1G32DBVR-TUDI	SOT23-5	Tape,Reel,3000	B32S	-40°C~125°C
SN74AHCT1G32DCKR-TUDI	SC70-5	Tape,Reel,3000	BG3	

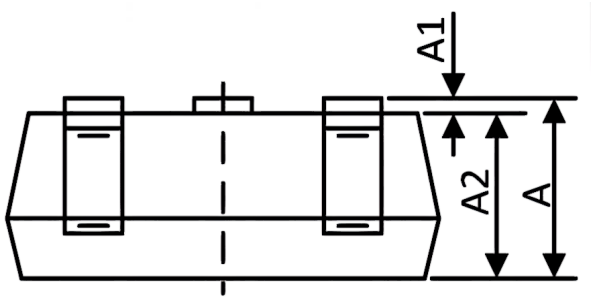
Revision history

Revison Number	Date	Revision	Page
V1.0	2018/7/10	New	1-14

Package SOT23-5

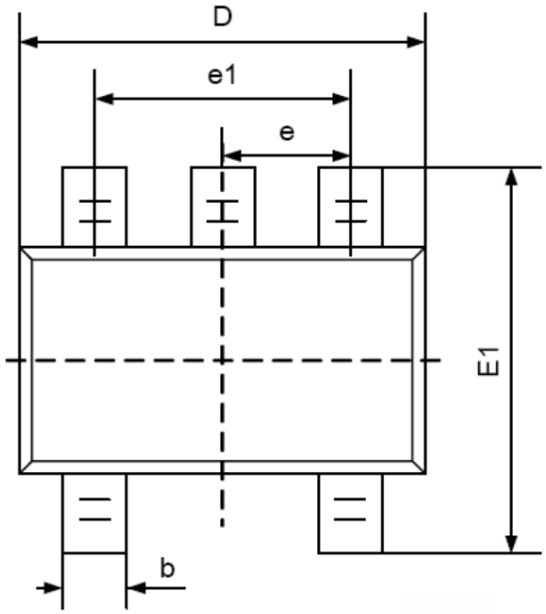


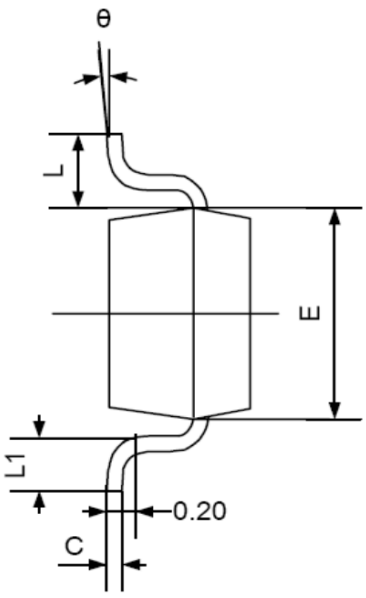


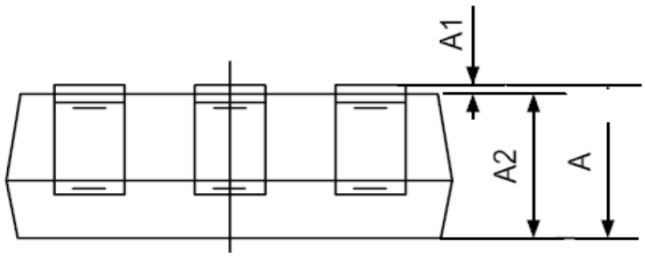


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
C	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

Package SC70-5







Symbol	DimensionsIn Millimeters		DimensionsIn Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
C	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650TYP		0.026TYP	
e1	1.200	1.400	0.047	0.055
L	0.525REF		0.021REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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